

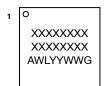


DATE 29 NOV 2011

- DIMENSIONING AND TOLERANCING PER
- ASME Y14.5M, 1994. CONTROLLING DIMENSIONS: MILLIMETERS.
- CONTROLLING DIMENSIONS: MILLIMETERS.
 DIMENSION & APPLIES TO PLATED
 TERMINAL AND IS MEASURED BETWEEN
 0.15 AND 0.30mm FROM THE TERMINAL TIP.
 COPLANARITY APPLIES TO THE EXPOSED
- PAD AS WELL AS THE TERMINALS.

	MILLIMETERS	
DIM	MIN	MAX
Α	0.80	1.00
A1		0.05
А3	0.20 REF	
b	0.15	0.25
D	5.00 BSC	
D2	3.40	3.60
Е	5.00 BSC	
E2	3.40	3.60
е	0.40 BSC	
K	0.35 REF	
L	0.30	0.50
L1		0.15

GENERIC MARKING DIAGRAM*



XXXXX = Specific Device Code = Assembly Location Α

= Wafer Lot WL = Year WW = Work Week = Pb-Free Package G

*This information is generic. Please refer to device data sheet for actual part

Pb-Free indicator, "G" or microdot " ■", may or may not be present.

E2 пппффпппп 0.10 M C A B Ф 0.05 M C NOTE 3 **BOTTOM VIEW**

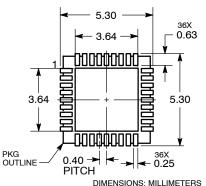
 $| \oplus | 0.10$ | C | A | B

RECOMMENDED SOLDERING FOOTPRINT

D2

10

DETAIL A



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